TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHC175F,TC74VHC175FT,TC74VHC175FK

#### Quad D-Type Flip Flop with Clear

The TC74VHC175 is an advanced high speed CMOS QUAD D-TYPE FLIP FLOP fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These four flip-flops are controlled by a clock input (CK) and a clear input ( $\overline{\rm CLR}$  ).

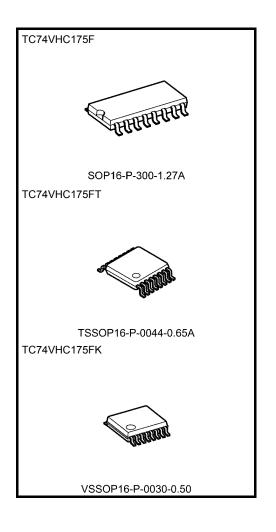
The information data applied to the D inputs (D1 thru D4) are transferred to the outputs (Q1 thru Q4 and  $\overline{Q1}$  thru  $\overline{Q4}$ ) on the positive-going edge of the clock pulse.

When the  $\overline{\text{CLR}}$  input is held low, the Q outputs are at the low logic level and the  $\overline{Q}$  outputs are at the high logic level, regardless of other input conditions.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### Features

- High speed:  $f_{max} = 210 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \pmod{at Ta} = 25 \circ C$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 5.5 V
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS175

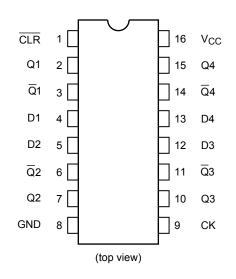


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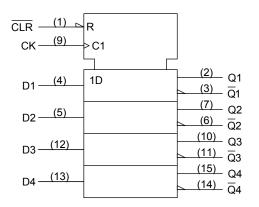
SOP16-P-300-1.27A	: 0.18 g (typ.)
TSSOP16-P-0044-0.65A	: 0.06 g (typ.)
VSSOP16-P-0030-0.50	: 0.02 g (typ.)

# <u>TOSHIBA</u>

### **Pin Assignment**



## **IEC Logic Symbol**

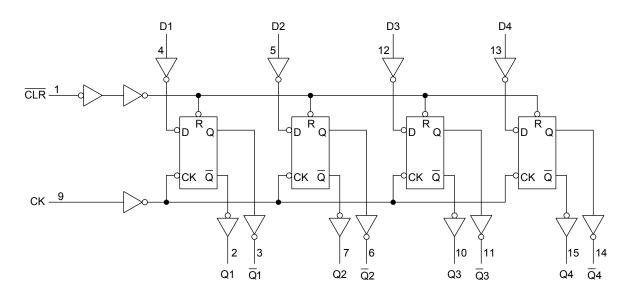


## Truth Table

	Inputs		Out	puts	Function
CLR	D	СК	Q	Q	T UNCLION
L	Х	Х	L	Н	Clear
Н	L		L	Н	—
Н	н		Н	L	—
Н	Х		Qn	$\overline{Q}_{n}$	No Change

X: Don't care

## System Diagram



#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	IIК	-20	mA
Output diode current	I <sub>OK</sub>	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Operating Range (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	<b>no</b> //	
	ul/uv	0 to 20 (V <sub>CC</sub> = 5 $\pm$ 0.5 V)	ns/V	

Note: The operating range must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit	
Characteriotice	Cymbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
High-level input voltage	VIH	_			1.50 V <sub>CC</sub> × 0.7		_	1.50 V <sub>CC</sub> × 0.7		V	
Low-level input voltage	VIL	_		2.0 3.0 to 5.5			0.50 V <sub>CC</sub> × 0.3		0.50 V <sub>CC</sub> × 0.3	V	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA I <sub>OH</sub> = -4 mA	2.0 3.0 4.5 3.0	1.9 2.9 4.4 2.58	2.0 3.0 4.5		1.9 2.9 4.4 2.48		V	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_		
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μΑ	2.0 3.0 4.5		0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1	V	
			I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 8 mA	3.0 4.5	_ _	_	0.36 0.36	_	0.44 0.44		
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±0.1		±1.0	μA	
Quiescent supply current	ICC	V <sub>IN</sub> = V <sub>C</sub>	<sub>C</sub> or GND	5.5	_	_	4.0	_	40.0	μA	

## Timing Requirements (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = −40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	t <sub>w (L)</sub>		3.3 ± 0.3	_	5.0	5.0	20
(CK)	t <sub>w (H)</sub>	_	5.0 ± 0.5	—	5.0	5.0	ns
Minimum pulse width	4		3.3 ± 0.3	_	5.0	5.0	20
( CLR )	t <sub>w (L)</sub>	—	5.0 ± 0.5	—	5.0	5.0	ns
Minimum oot un timo		_	3.3 ± 0.3	-	5.0	5.0	20
Minimum set-up time	t <sub>s</sub>		5.0 ± 0.5	—	4.0	4.0	ns
Minimum hold time	<b>.</b>		3.3 ± 0.3	-	1.0	1.0	20
Minimum noid time	t <sub>h</sub>	_	5.0 ± 0.5	—	1.0	1.0	ns
Minimum removal time	4		3.3 ± 0.3	_	5.0	5.0	20
(CLR)	t <sub>rem</sub>	_	5.0 ± 0.5	—	5.0	5.0	ns

#### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Tes	Test Condition		-	Ta = 25°(	2		−40 to °C	Unit	
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max		
			3.3 ± 0.3	15	_	7.5	11.5	1.0	13.5		
Propagation delay time	t <sub>pLH</sub>		$5.5 \pm 0.5$	50	_	10.0	15.0	1.0	17.0	ns	
(CK-Q, Q)	t <sub>pHL</sub>	_	5.0 ± 0.5	15	_	4.8	7.3	1.0	8.5	115	
· · ·			$5.0 \pm 0.5$	50	_	6.3	9.3	1.0	10.5		
			3.3 ± 0.3	15	_	6.3	10.1	1.0	12.0		
Propagation delay time	t <sub>pLH</sub>			$5.5 \pm 0.5$	50	_	8.8	13.6	1.0	15.5	ns
$(\overline{CLR} - Q, \overline{Q})$	t <sub>pHL</sub>				5.0 ± 0.5	15	_	4.3	6.4	1.0	7.5
<b>、</b> · · <i>,</i>			5.0 ± 0.5	50	_	5.8	8.4	1.0	9.5		
			3.3 ± 0.3	15	90	140	—	75	—		
Maximum clock	f			50	50	75	—	45	—	MHz	
frequency	f <sub>max</sub>	_	5.0 ± 0.5	15	150	210	_	125	_		
			$5.0 \pm 0.5$	50	85	115	_	75	_		
	t <sub>osLH</sub>	(Note 1)	3.3 ± 0.3	50	_	_	1.5	_	1.5	ns	
Output to output skew	t <sub>osHL</sub>	(NOLE I)	5.0 ± 0.5	50	_	_	1.0	_	1.0	115	
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF	
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)	_	44	_	_	_	pF	

Note 1: Parameter guaranteed by design.

 $t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per bit)

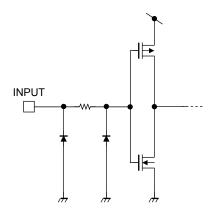
And the total  $C_{PD}$  when n pcs.of flip flop operate can be gained by the following equation:

C<sub>PD</sub> (total) = 30 + 14·n

#### Noise Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition	Ta =	Unit		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Max	Unit
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic $V_{OL}$	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage	VIHD	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	-	1.5	V

# Input Equivalent Circuit

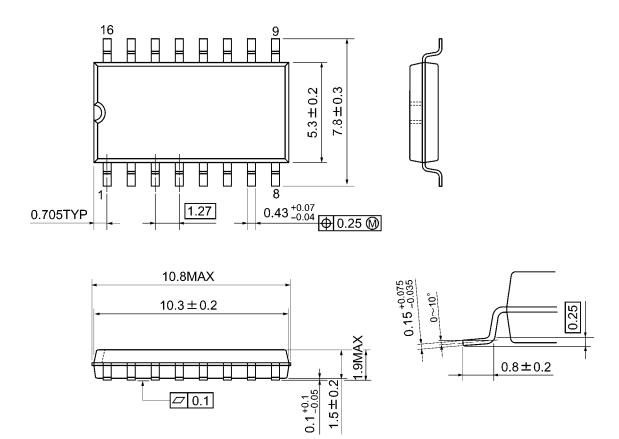




#### **Package Dimensions**

SOP16-P-300-1.27A

Unit: mm

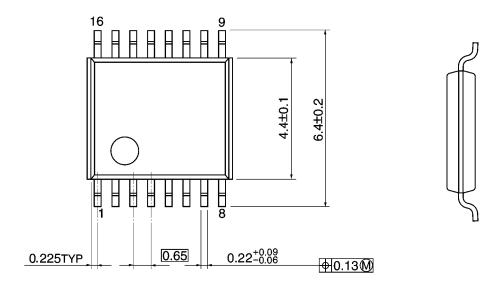


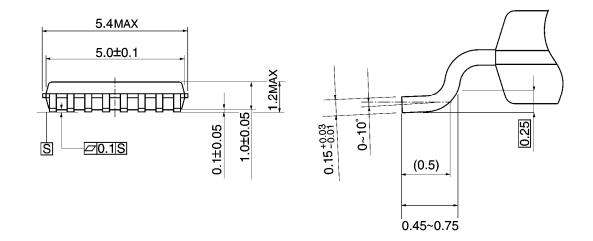
Weight: 0.18 g (typ.)

#### **Package Dimensions**

TSSOP16-P-0044-0.65A

Unit: mm





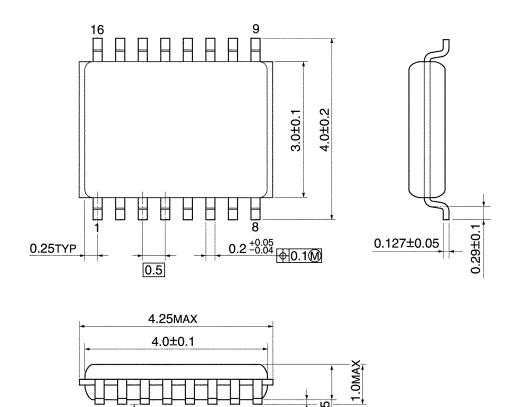
Weight: 0.06 g (typ.)



#### **Package Dimensions**

VSSOP16-P-0030-0.50

Unit: mm



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0.1±0.05 0.8±0.05



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